BLF548

UHF push-pull power MOS transistor Rev. 5 — 1 September 2015



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Thank you for your cooperation and understanding,

Ampleon

Product specification

UHF push-pull power MOS transistor

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FEATURES

- High power gain
- · Easy power control
- Good thermal stability
- Gold metallization ensures excellent reliability
- Designed for broadband operation.

DESCRIPTION

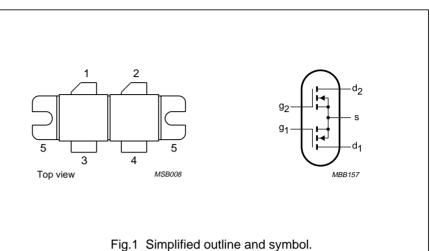
Dual push-pull silicon N-channel enhancement mode vertical D-MOS transistor designed for communications transmitter applications in the UHF frequency range.

The transistor is encapsulated in a 4-lead, SOT262A2 balanced flange package, with two ceramic caps. The mounting flange provides the common source connection for the transistors.

PINNING - SOT262A2

PIN	DESCRIPTION			
1	drain 1			
2	drain 2			
3	gate 1			
4	gate 2			
5	source			

PIN CONFIGURATION



CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A, and SNW-FQ-302B.

WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO discs are not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

QUICK REFERENCE DATA

RF performance at T_h = 25 °C in a push-pull common source test circuit.

MODE OF OPERATION	f	V _{DS}	P _L	G _p	η _D
	(MHz)	(V)	(W)	(dB)	(%)
CW, class-B	500	28	150	>10	>50

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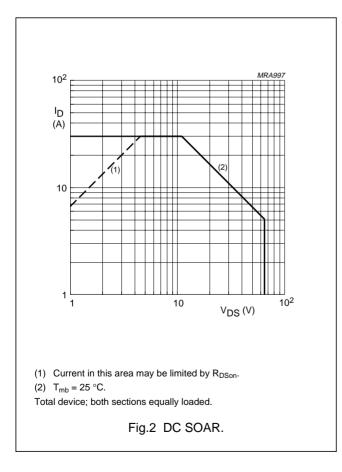
LIMITING VALUES

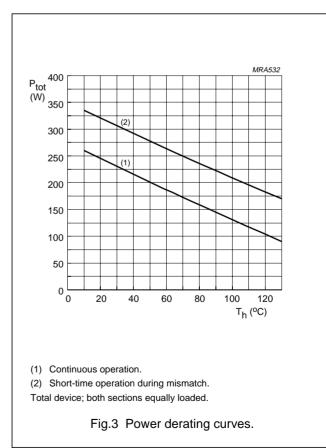
In accordance with the Absolute Maximum System (IEC 60134).

SYMBOL	PARAMETER	R CONDITIONS		MAX.	UNIT			
Per transiste	Per transistor section unless otherwise specified							
V _{DS}	drain-source voltage		-	65	V			
V _{GS}	gate-source voltage		-	±20	V			
ID	drain current (DC)		_	15	A			
P _{tot}	total power dissipation	$T_{mb} \le 25$ °C; total device; both sections equally loaded	-	330	W			
T _{stg}	storage temperature		-65	+150	°C			
Tj	junction temperature		-	200	°C			

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
R _{th j-mb}	thermal resistance from junction to mounting base	T_{mb} = 25 °C; P_{tot} = 330 W; total device; both sections equally loaded	0.5	K/W
R _{th mb-h}	thermal resistance from mounting base to heatsink	total device; both sections equally loaded	0.15	K/W





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CHARACTERISTICS

 $T_i = 25 \ ^{\circ}C$ unless otherwise specified.

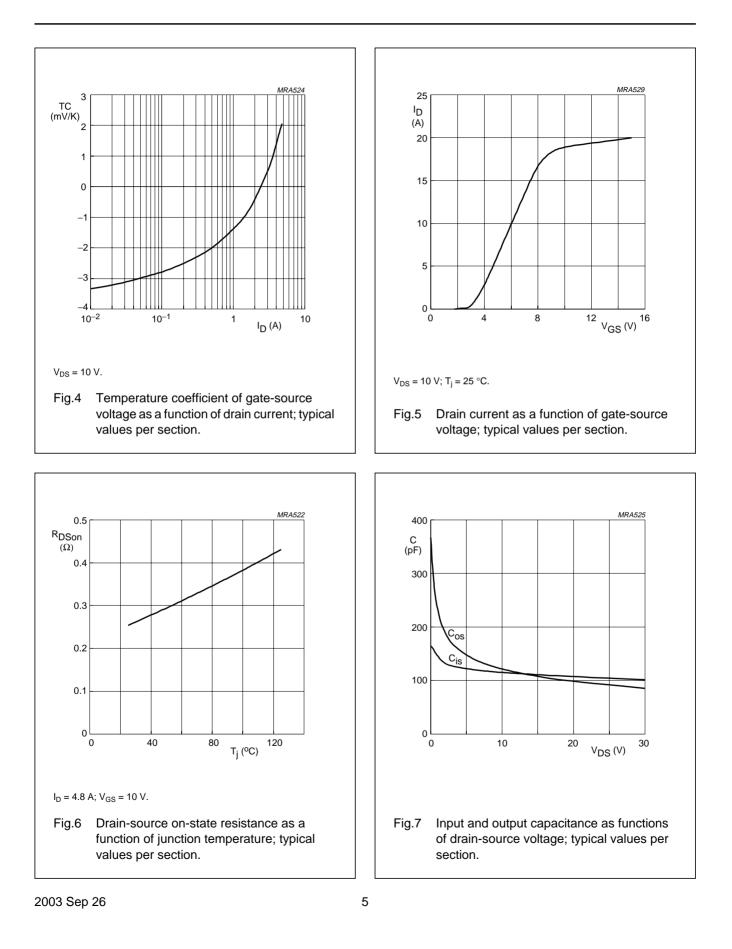
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Per transist	or section					
V _{(BR)DSS}	drain-source breakdown voltage	$V_{GS} = 0; I_D = 40 \text{ mA}$	65	_	_	V
I _{DSS}	drain-source leakage current	$V_{GS} = 0; V_{DS} = 28 V$	-	-	0.5	mA
I _{GSS}	gate-source leakage current	$V_{GS} = \pm 20 \text{ V}; V_{DS} = 0$	-	-	1	μA
V _{GSth}	gate-source threshold voltage	I _D = 160 mA; V _{DS} = 10 V	2	_	4	V
9 _{fs}	forward transconductance	I _D = 4.8 A; V _{DS} = 10 V	2.4	3.5	_	S
R _{DSon}	drain-source on-state resistance	I _D = 4.8 A; V _{GS} = 10 V	-	0.25	0.3	Ω
I _{DSX}	on-state drain current	V _{GS} = 15 V; V _{DS} = 10 V	16	20	_	A
C _{is}	input capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	_	105	_	pF
C _{os}	output capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	-	90	-	pF
C _{rs}	feedback capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	_	25	_	рF

V_{GS} group indicator

GROUP	LIMITS (V)		GROUP		NITS V)
	MIN.	MAX.		MIN.	MAX.
А	2.0	2.1	0	3.3	3.4
В	2.1	2.2	Р	3.4	3.5
С	2.2	2.3	Q	3.5	3.6
D	2.3	2.4	R	3.6	3.7
Е	2.4	2.5	S	3.7	3.8
F	2.5	2.6	Т	3.8	3.9
G	2.6	2.7	U	3.9	4.0
Н	2.7	2.8	V	4.0	4.1
J	2.8	2.9	W	4.1	4.2
K	2.9	3.0	X	4.2	4.3
L	3.0	3.1	Y	4.3	4.4
М	3.1	3.2	Z	4.4	4.5
Ν	3.2	3.3			

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Ruggedness in class-B operation

The BLF548 is capable of withstanding a load mismatch corresponding to VSWR = 10: 1 through all phases under the following conditions: V_{DS} = 28 V; f = 500 MHz at rated output power.

MRA521 100 Crs (pF) 80 60 40 20 0 0 10 20 30 $V_{\text{DS}}(V)$ Feedback capacitance as a function of Fig.8 drain-source voltage; typical values per section.

APPLICATION INFORMATION FOR CLASS-B OPERATION

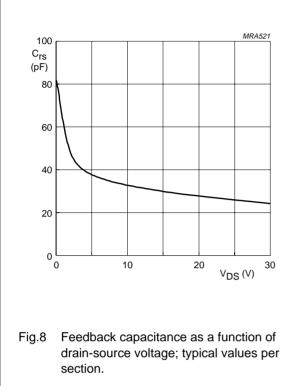
 T_h = 25 °C; $R_{th mb-h}$ = 0.15 K/W, unless otherwise specified. RF performance in a common source, class-B, push-pull test circuit.

MODE OF OPERATION	f	V _{DS}	I _{DQ}	PL	G _p	η _D
	(MHz)	(V)	(mA)	(W)	(dB)	(%)
CW, class-B	500	28	2 x 160	150	>10 typ. 11	>50 typ. 55

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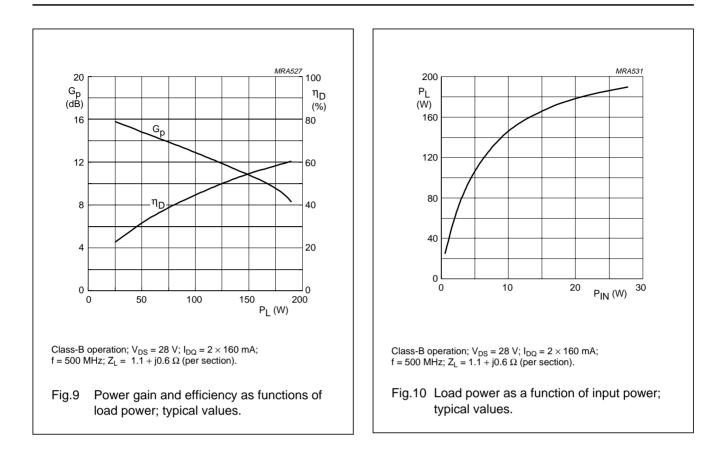
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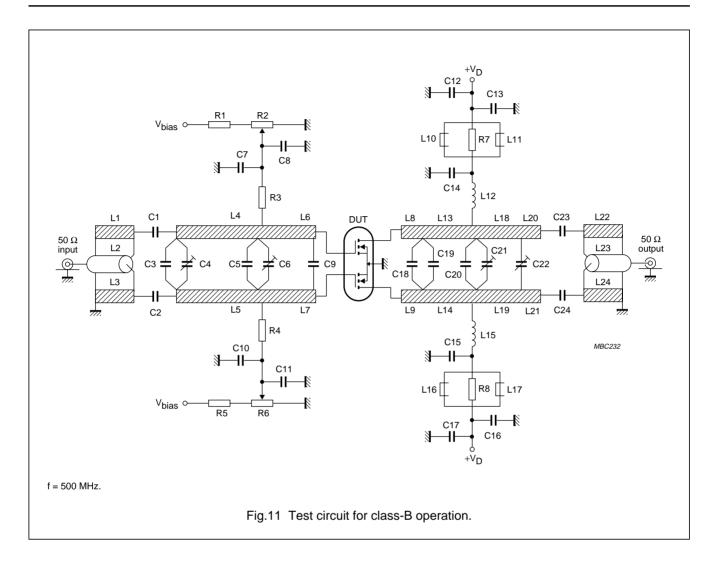
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List of components class-B test circuit (see Fig.11)

COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C2	multilayer ceramic chip capacitor; note 1	22 pF		
C3	multilayer ceramic chip capacitor; note 1	16 pF		
C4	film dielectric trimmer	2 to 9 pF		2222 809 09005
C5	multilayer ceramic chip capacitor; note 2	27 pF		
C6, C21, C22	film dielectric trimmer	2 to 18 pF		2222 809 09006
C7, C10, C14, C15	multilayer ceramic chip capacitor; note 1	390 pF		
C8, C11, C12, C17	multilayer ceramic chip capacitor	100 nF		2222 852 47104
C9	multilayer ceramic chip capacitor; note 3	$2 \times 56 \text{ pF}$ in series		

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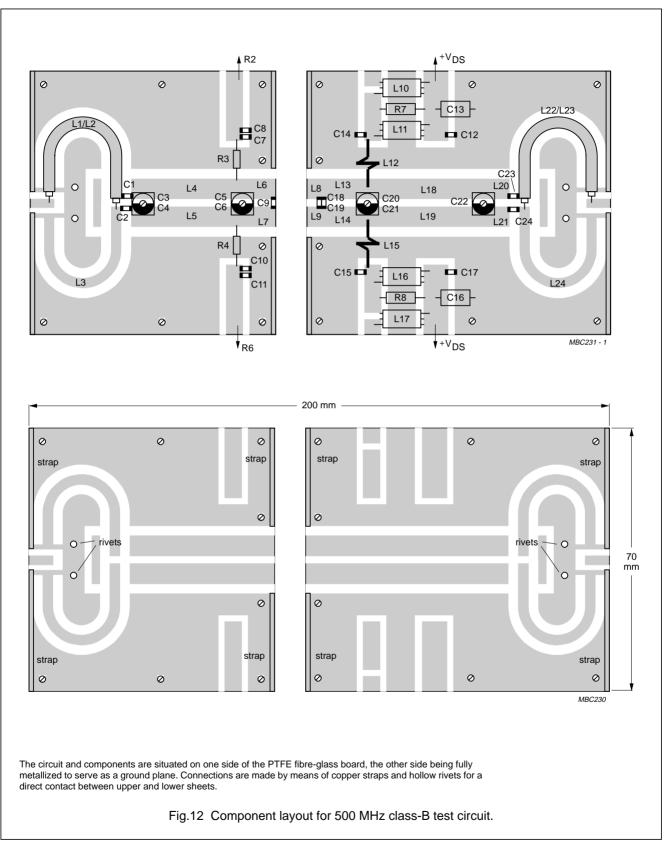
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COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C13, C16	electrolytic capacitor	10 μF, 63 V		2222 030 38109
C18	multilayer ceramic chip capacitor; note 2	18 pF		
C19	multilayer ceramic chip capacitor; note 2	12 pF		
C20	multilayer ceramic chip capacitor; note 2	8.2 pF		
C23, C24	multilayer ceramic chip capacitor; note 1	30 pF		
L1, L3, L22, L24	stripline; note 4	34.5 Ω	length 66.5 mm width 4 mm	
L2, L23	semi-rigid cable; note 5	50 Ω	length 66.5 mm width 3.6 mm	
L4, L5	stripline; note 4	22.3 Ω	length 35 mm width 7 mm	
L6, L7	stripline; note 4	22.3 Ω	length 10 mm width 7 mm	
L8, L9	stripline; note 4	22.3 Ω	length 5.5 mm width 7 mm	
L10, L11, L16, L17	grade 3B Ferroxcube wideband RF choke			4312 020 36642
L12, L15	1 turn enamelled 1.5 mm copper wire	17 nH	length 5 mm int. dia. 9 mm leads 2×5 mm	
L13, L14	stripline; note 4	22.3 Ω	length 15 mm width 7 mm	
L18, L19	stripline; note 4	22.3 Ω	length 36 mm width 7 mm	
L20, L21	stripline; note 4	22.3 Ω	length 8.5 mm width 7 mm	
R1, R5	0.4 W metal film resistor	24.7 kΩ		2322 151 72473
R2, R6	10 turn potentiometer	5 kΩ		
R3, R4	0.4 W metal film resistor	10.5 kΩ		2322 151 71053
R7, R8	1 W metal film resistor	10 Ω		2322 151 51009

Notes

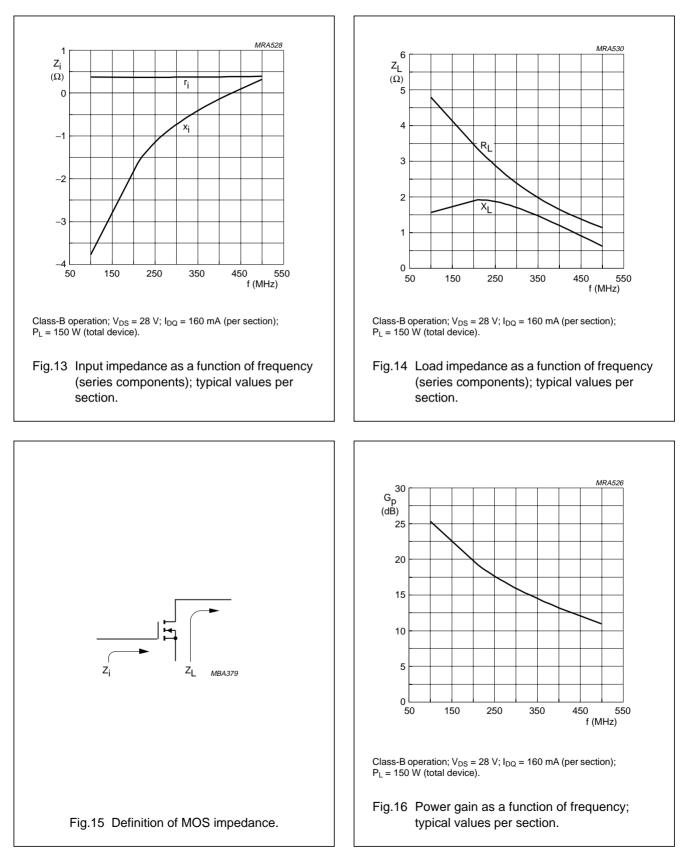
- 1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
- 2. American Technical Ceramics (ATC) capacitor, type 175B or other capacitor of the same quality.
- 3. American Technical Ceramics (ATC) capacitor, type 100A or other capacitor of the same quality.
- 4. The striplines are on a double copper-clad printed-circuit board, with PTFE fibre-glass dielectric (ϵ_r = 2.2), thickness 0.79 mm.
- 5. Cables L2 and L23 are soldered to striplines L1 and L22 respectively.

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BLF548 scattering parameters

 $V_{DS} = 28 \text{ V}; I_{D} = 40 \text{ mA}; \text{ note } 1$

f (ML)-)		S ₁₁	S	21	S	12	s	22
f (MHz)	s ₁₁	$\angle \Phi$	s ₂₁	$\angle \Phi$	s ₁₂	$\angle \Phi$	S ₂₂	$\angle \Phi$
5	0.99	-14.0	13.60	171.0	0.02	81.0	0.89	-12.8
10	0.98	-27.6	13.20	162.0	0.04	72.4	0.87	-25.3
20	0.93	-52.0	11.90	146.0	0.07	57.1	0.82	-48.0
30	0.88	-72.0	10.30	134.0	0.09	44.8	0.77	-66.6
40	0.84	-87.7	8.93	124.0	0.10	35.2	0.72	-81.3
50	0.81	-100.0	7.75	116.0	0.11	27.7	0.68	-93.0
60	0.79	-110.0	6.78	110.0	0.12	21.6	0.66	-102.0
70	0.77	-118.0	6.00	104.0	0.12	16.7	0.64	-109.0
80	0.76	-124.0	5.36	99.8	0.12	12.5	0.63	-115.0
90	0.75	-129.0	4.82	95.9	0.12	8.9	0.62	-120.0
100	0.75	-133.0	4.37	92.3	0.13	5.7	0.61	-124.0
125	0.74	-141.0	3.53	84.7	0.13	-1.1	0.61	-131.0
150	0.74	-147.0	2.94	78.3	0.13	-6.6	0.61	-137.0
175	0.74	-151.0	2.50	72.6	0.12	-11.5	0.62	-140.0
200	0.75	-154.0	2.16	67.5	0.12	-15.8	0.64	-143.0
250	0.77	-159.0	1.67	58.4	0.12	-23.3	0.67	-148.0
300	0.78	-163.0	1.33	50.4	0.11	-29.7	0.70	-151.0
350	0.80	-167.0	1.09	43.1	0.10	-35.3	0.73	-154.0
400	0.82	-169.0	0.91	36.6	0.10	-40.3	0.75	-157.0
450	0.84	-172.0	0.77	30.6	0.09	-44.7	0.78	-160.0
500	0.85	-175.0	0.66	25.1	0.08	-48.6	0.80	-162.0
600	0.89	-179.0	0.50	15.6	0.07	-55.2	0.84	-167.0
700	0.90	177.0	0.39	7.5	0.06	-60.4	0.88	-170.0
800	0.92	173.0	0.32	0.6	0.05	-64.3	0.90	-174.0
900	0.93	169.0	0.26	-5.4	0.04	-67.3	0.92	-177.0
1000	0.94	166.0	0.22	-10.8	0.04	-69.2	0.93	-179.0

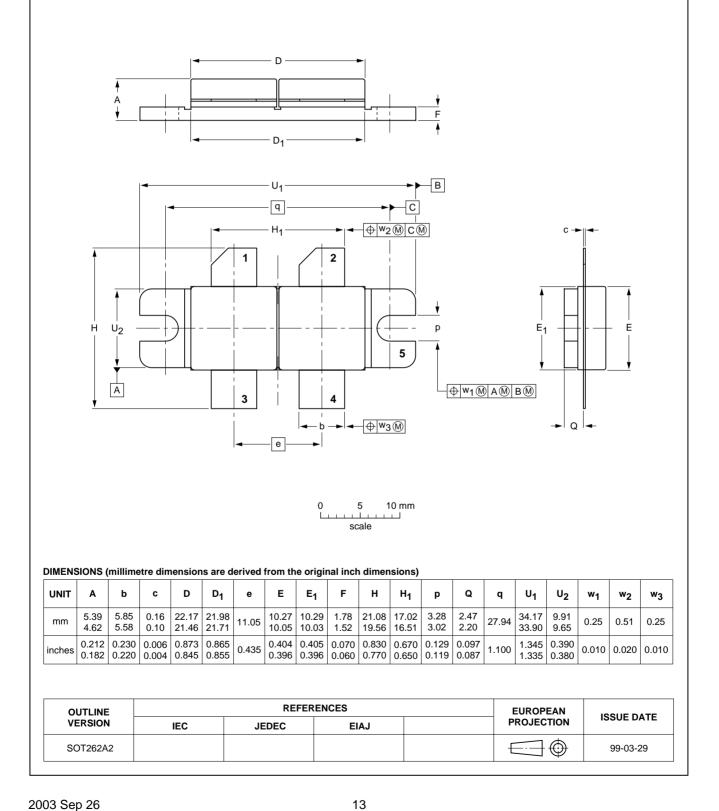
Note

1. For more extensive s-parameters see internet: http://www.semiconductors.philips.com/markets/communications/wirelesscommunications/broadcast

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PACKAGE OUTLINE

Flanged double-ended ceramic package; 2 mounting holes; 4 leads



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SOT262A2

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